506704875 06/09/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6751694

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
HISAYUKI NAGAMINE	04/27/2021

RECEIVING PARTY DATA

Name:	POWERCHIP SEMICONDUCTOR MANUFACTURING CORPORATION
Street Address:	NO. 18, LI-HSIN RD. 1, HSINCHU SCIENCE PARK,
City:	HSINCHU
State/Country:	TAIWAN

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17342565

CORRESPONDENCE DATA

Fax Number: (949)391-4699

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Correspondent Name: JCIPRNET

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Address Line 4: TAIPEI, TAIWAN 100404

ATTORNEY DOCKET NUMBER:	107494-US-PA
NAME OF SUBMITTER:	BELINDA LEE
SIGNATURE:	/Belinda Lee/
DATE SIGNED:	06/09/2021

Total Attachments: 3

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> **PATENT REEL: 056475 FRAME: 0736** 506704875

DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Declaration Submitted With Initial Filing
OR
Declaration Submitted After Initial Filing (surcharge 37 CFR 1.16(f) required)
(Title of the Invention)
SUB-SENSE AMPLIFIER AND SEMICONDUCTOR MEMORY DEVICE
As a below named inventor (hereinafter designated as the undersigned), I hereby
declare that:
This declaration is directed to:
☐ The attached application,
OR
United States Application Number or PCT International application number
Filed on

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the application.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

PT.AP-2409 107494-US-PA

DECLARATION AND ASSIGNMENT

FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements

described in the application identified.

WHEREAS, 1. Powerchip Semiconductor Manufacturing Corporation

of No. 18, Li-Hsin Rd. 1, Hsinchu Science Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the

said invention and application and in any U.S. Letters Patent which may be granted on the

same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and

valuable consideration, receipt of which is hereby acknowledged by the undersigned, the

undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign

and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their

rights, title and interest in and to the said invention and application and all future

improvements thereon, and in and to any Letters Patent which may hereafter be granted on the

same in the United States, the said rights, title and interest to be held and enjoyed by said

Assignee as fully and exclusively as it would have been held and enjoyed by said the

undersigned had this Assignment and transfer not been made, to the full end and term of any

Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole

or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but

at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or

applications, execute, verify, acknowledge and deliver all such further papers, including

applications for Letters Patent and for the reissue thereof, and instruments of assignment and

transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain

or maintain Letters Patent for said invention and improvement, and to vest title thereto in said

Assignee, or Assignee's successors and assigns.

- 2 -

PATENT

REEL: 056475 FRAME: 0738

PT.AP-2409 107494-US-PA

DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Signature: Nisaywei Nagamine Date: 4/27/2021

Legal Name of Sole or First Inventor: Hisayuki Nagamine

Residence: Tokyo, Japan

Mailing Address: 8-12-1-107 Minamisenju, Arakawaku, Tokyo 116-0003, Japan

- 3 -

PATENT REEL: 056475 FRAME: 0739